

THIS SPEC IS OBSOLETE

Spec No: 002-05043

Spec Title: DATASHEET ERRATA FOR THE S6E2DF

SERIES 32-BIT ARM (R) CORTEX (R)-M4F

BASED MICROCONTRÓLLER

Replaced by: NONE



November 29, 2016

Datasheet Errata for the S6E2DF Series 32-bit ARM® Cortex®-M4F based Microcontroller

This document describes the errata for the S6E2DF Series 32-bit ARM® Cortex®-M4F based Microcontroller Data Sheet. Compare this document to the device's data sheet for a complete functional description.

Contact your local Cypress Sales Representative, if you have questions.

Part Numbers Affected

Part Number	
S6E2DF Series	

Page	Item	Description						
		e: DS709-00031-1v0-E						
	June 25, 201							
64	9. Handling	"Sub Crystal Oscillator" should be added as indicated by the shading below.						
	Devices							
		■Surface mount type						
		Size: More than 3.2 mm × 1.5 mm						
		Load capacitance: Approximately 6 pF to 7 pF						
		When the Standard setting (CCS/CCB=11001110)						
		Load capacitance: Approximately 4 pF to 7 pF						
		When the low power setting (CCS/CCB=00000100)						
		■Lead type						
		Load capacitance: Approximately 6 pF to 7 pF						
		When the Standard setting (CCS/CCB=11001110)						
		Load capacitance: Approximately 4 pF to 7 pF						
		When the low power setting (CCS/CCB=00000100)						

Page	Item				Desc	cription				
92	14.3.1	Table 14-10	should be	e added		by the shading	g belov	/ .		
	Current									
	Rating	Table 14-10 Typical and Maximum Current Consumption in Deep Standby Stop Mode, Deep Standby RTC Mode and VBAT								
		Pin Fraguency Value								
		Parameter	Symbol	Name	Conditions	(MHz)	Тур	Max	Unit	Remarks
							0.009	0.032	μA	*3, *4, *5 T _A =+25°C
					RTC stop		-	0.994	μA	*3, *4, *5 T _A =+85°C
							-	1.491	μA	*3, *4, *5 T _A =+105°C
							1.0	1.636	μA	*3, *4 T _A =+25°C
		Power supply current	ICCVBAT	VBAT	RTC *6 operation	-	-	2.828	μA	*3, *4 T _A =+85°C
							-	4.242	μA	*3, *4 T _A =+105°C
							0.7	1.153	μA	*3, *4 T _A =+25°C
					RTC *7 operation		-	2.277	μA	*3, *4 T _A =+85°C
							-	3.416	μA	*3, *4 T _A =+105°C
		*1: V _{CC} =	=3.3 V							
		*2: V _{CC} =	=3.6 V							
		*3: Whe	n all ports are f	ïxed.						
		*4: Whe	n LVD is OFF							
		*5: Whe	n sub oscillatio	n is OFF						
		*6: Whe	n using the crys	stal oscillator	of 32 kHz (including	ng the current consump	tion of the	oscillation	n circuit)	
		When	the Standard	l setting (CO	CS/CCB=110011	10)				
					of 32 kHz (includin	ng the current consump	otion of the	oscillation	n circuit)	
										¥

Page	Item			Description						
178	15. Ordering Information	Ordering Information should be corrected as indicated by the shading below.								
		(Error)		T						
			Part Number	Package						
			S6E2DF5G0AGV20000	Plastic • LQFP (0.5 mm pitch), 120 pin						
			S6E2DF5GJAMV20000	(FPT-120P-M21)						
			S6E2DF5J0AGV20000	Plastic • LQFP (0.5 mm pitch), 176 pin (FPT-176P-M07)						
			S6E2DF5G0AGB30000	Plastic • PFBGA (0.5 mm pitch), 161 pin (FDJ161)						
			S6E2DF5G0AGZ20000	Plastic • Ex-LQFP (0.5 mm pitch), 120 pin (LEM120)						
		(Correct)								
			Part Number	Package						
			S6E2DF5G0AGV20000	Plastic • LQFP (0.5 mm pitch), 120 pin						
			S6E2DF5GJAMV20000	(FPT-120P-M21)						
			S6E2DF5J0AGV20000	Plastic • LQFP (0.5 mm pitch), 176 pin (FPT-176P-M07)						
			S6E2DF5G0AGB30000	Plastic • PFBGA (0.5 mm pitch), 161 pin (FDJ161)						
			S6E2DF5G0AGE20000	Plastic • Ex-LQFP (0.5 mm pitch), 120 pin (LEM120)						

Page	Item	De	scription							
11	2. Features	Note should be added as indicated by the								
		(Error)								
		GDC Unit								
		Controller for external graphics display								
		Accelerator for 2D block image transfer (blit) operations								
		Embedded SRAM video memory	Interfore for an		tamaiama\					
		High-Speed Quad SPI (Serial Peripheral SDRAM interface for external memory ex		ternal memory	extensions)					
		HBI (Hyper Bus Interface) interface for ex		extensions						
		Maximum core system clock frequency:								
		(Correct)								
		GDC Unit								
		Controller for external graphics display								
		Accelerator for 2D block image transfer (blit) operations							
		Embedded SRAM video memory								
		High-Speed Quad SPI (Serial Peripheral SDRAM interface for external memory ex		ternal memory	extensions)					
		HBI (Hyper Bus Interface) interface for ex		extensions						
		Maximum core system clock frequency:		0.0000000000000000000000000000000000000						
		Note: - User can leverage the internal VRAM and external HyperRAM as a graphics memory allowed to be written by GDC.								
15	4. Packages	"Packages" should be corrected as indica	ted by the shad	ing below.						
		(Error)								
		Product Name	S6E2DF5G0A	S6E2DF5J0A	S6E2DF5GJA					
		Package LQFP: FPT-120P-M21 (0.5 mm pitch)								
İ		LQFP: FPT-176P-M07 (0.5 mm pitch)	0	-	0					
		PFBGA: FDJ161 (0.5 mm pitch)	-	0	-					
		Ex_LQFP(TEQFP): LEM120 (0.5 mm pitch)	0							
		O: Supported								
		S. Supported								
		(Correct)								
		Product Name								
		Package Product Name	S6E2DF5G0A	S6E2DF5J0A	S6E2DF5GJA					
		LQFP: FPT-120P-M21 (0.5 mm pitch)	O	-	0					
		LQFP: FPT-176P-M07 (0.5 mm pitch)	-	0	-					
		FBGA: FDJ161 (0.5 mm pitch)	0	-	-					
		Ex_LQFP(TEQFP): LEM120 (0.5 mm pitch)		1	-					
		O: Supported □: In development			-					
	1	II.								

Page	Item		Description									
	5. Pin	S	Signal name should be corrected as below.									
	Assignment	() I)	(Error) GE_SPCSX_0 (Correct) GE_SPCSX0 (Error) GE_HBCSX_0 (Correct) GE_HBCSX0 (Error) GE_HBCSX_1 (Correct) GE_HBCSX1									
21, 23, 48	6. Pin Descriptions	(I (I (I	Error) GE_SPCSX_0 (Correct) GE_SPCSX0 Error) GE_HBCSX_0 (Correct) GE_HBCSX0 Error) GE_HBCSX_1 (Correct) GE_HBCSX1									
67	10. Block Diagram	(1)	Error) GE_SPCSX_0 (Correct) GE_SPCSX0 Error) GE_HBCSX_0/1 (Correct) GE_HBCSX0/1									
93	14.3 DC Characteristi cs	b	VFLASH memor elow. Error)	y Standby (current"	should be co	rrected	d as ind	dicated	d by th	e shading	
			Parameter	Symbol	Pin	Conditions		Value	Unit		Remarks	
			VFLASH memory		name	At Standby	Min	Typ 15	Max 25	μА		
			VFLASH memory Read current	$I_{CCVFLASH}$	VCC	At Read	_	9	14	mA	40MHz	
			VFLASH memory write/erase current			At Write/Erase	-	20	20	mA	80MHz	
		((Correct)									
		(,		Pin			Value				
			Parameter	Symbol	name	Conditions	Min	Тур	Max	Unit	Remarks	
			VFLASH memory Standby current			At Standby	-	15	35	μΑ		
			VFLASH memory	I _{CCVFLASH}	VCC	At Read		9	14	mA	40MHz	
			Read current	ICCVFLASH	, , ,			13	20	11121	80MHz	
			VFLASH memory write/erase current			At Write/Erase	-	20	25	mA		
										Ť		
162, 163, 164	14.4 AC Characteristi cs	(I (I	Signal name should be corrected as below. (Error) GE_SPCSX_0 (Correct) GE_SPCSX0 (Error) GE_HBCSX_0 (Correct) GE_HBCSX0 (Error) GE_HBCSX_1 (Correct) GE_HBCSX1									

Document History Page

Document Title: Datasheet Errata for the S6E2DF Series 32-bit ARM® Cortex®-M4F based Microcontroller Document Number: 002-05043								
Rev.	ECN No.	Orig. of Change	Description of Change					
**	_	AKIH	nitial Release					
*A	5037784	AKIH	Converted to Cypress format					
*B	5546786	HTER	lade the corrections to datasheet spec, 002-05042; this spec is now obsolete.					

Cypress Semiconductor 198 Champion Court San Jose, CA 95134-1709 Phone: 408-943-2600 Fax: 408-943-4730 http://www.cypress.com

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